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Vishay Siliconix



Top View

Bottom View

PRODUCT SUMMARY					
V _{DS} (V)	60				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0015				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0021				
Q _g typ. (nC)	41				
I _D (A)	186				
Configuration	Single				

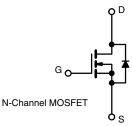
FEATURES

N-Channel 60 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- Very low R_{DS} Q_q figure-of-merit (FOM)
- Tuned for the lowest R_{DS} $\mathsf{Q}_{\mathsf{oss}}$ FOM
- 100 % R_q and UIS tested
- Top side cooling feature provides additional venue for thermal transfer
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- Primary side switch
- DC/DC converter
- Solar micro inverter
- Motor drive switch
- · Battery and load switch
- Industrial



RoHS

COMPLIANT HALOGEN

FREE

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SIDR626LDP-T1-RE3

PARAMETER Drain-source voltage		SYMBOL	LIMIT	UNIT	
		V _{DS}	60		
Gate-source voltage		V _{GS}	± 20		
-	T _C = 25 °C		204		
Continuous durin surrent (T 150 °C)	T _C = 70 °C		163		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	45.6 ^{b, c}		
	T _A = 70 °C		36.5 ^{b, c}	A	
Pulsed drain current (t = 100 µs)		I _{DM}	300		
Ocartine and a durin dia de coment	T _C = 25 °C		113		
Continuous source-drain diode current	T _A = 25 °C	I _S	5.6 ^{b, c}		
Single pulse avalanche current L = 0.1 mH		I _{AS}	50		
Single pulse avalanche energy		E _{AS}	125	mJ	
	T _C = 25 °C		125		
	T _C = 70 °C		80	w	
Maximum power dissipation	T _A = 25 °C	P _D	6.25 ^{b, c}	vv	
	T _A = 70 °C	1	4 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg} -55 to +150		°C	
Soldering recommendations (peak temperature) ^c			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	15	20	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.8	1	°C/W
Maximum junction-to-case (source)	Steady state	R _{thJC}	1.1	1.4	

Notes

Package limited а.

Surface mounted on 1" x 1" FR4 board b.

t = 10 s c.

See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8DC is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 54 °C/W d.

e.

f.

g. T_C = 25 °C

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Document Number: 77277

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	• •					1
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 1 mA$	60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 1 mA	-	37	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.9	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA
Zava anto veltogo droin overent		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	15	μA
On-state drain current ^a	state drain current ^a $I_{D(on)}$ $V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$		40	-	-	Α
	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0012	0.0015	0
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0017	0.0021	Ω
Forward transconductance a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	140	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	5900	-	
Output capacitance	C _{oss}	V_{DS} = 30 V, V_{GS} = 0 V, f = 1 MHz	-	1340	-	pF
Reverse transfer capacitance	C _{rss}				-	
Total gata abarga	0	V_{DS} = 30 V, V_{GS} = 10 V, I_{D} = 20 A	-	89	135	
Total gate charge	Qg		-	41	62	
Gate-source charge	Q _{gs}	V_{DS} = 30 V, V_{GS} = 4.5 V, I_{D} = 20 A	-	17.4	-	nC
Gate-drain charge	Q _{gd}		-	10.8	-	
Output charge			-	80	-	
Gate resistance	Rg	f = 1 MHz	0.3	0.88	1.5	Ω
Turn-on delay time	t _{d(on)}		-	17	34	
Rise time	t _r	$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 3 \Omega, \text{ I}_{D} \cong 20 \text{ A},$	-	64	128	1
Turn-off delay time	t _{d(off)}	$V_{GEN} = 10$ V, $R_g = 1$ Ω	-	45	90	-
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	40	80	ns
Rise time	t _r	V_{DD} = 30 V, R_L = 1.5 Ω , $I_D \cong$ 20 A,	-	235	470	
Turn-off delay time	t _{d(off)}	V_{GEN} = 4.5 V, R_g = 1 Ω	-	47	94	
Fall time	t _f		-	20	40	
Drain-Source Body Diode Characterist	cs					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	113	A
Pulse diode forward current	I _{SM}		-	-	400	A
Body diode voltage	dy diode voltage V _{SD}		-	0.71	1.1	V
Body diode reverse recovery time	t _{rr}		-	54	108	ns
Body diode reverse recovery charge	Q _{rr}			70	140	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	27	-	ns
Reverse recovery rise time	t _b		-	27	-	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

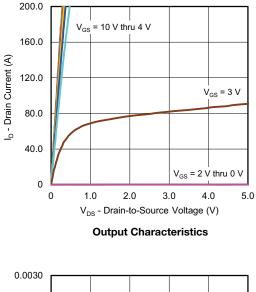
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

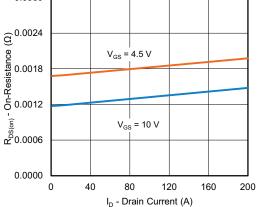
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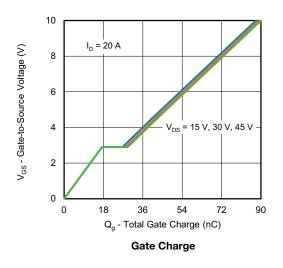
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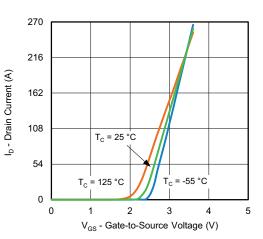
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



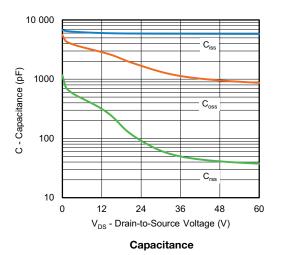


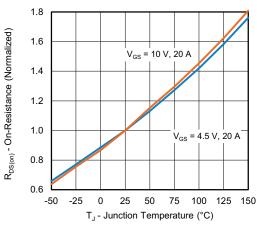
On-Resistance vs. Drain Current and Gate Voltage





Transfer Characteristics





On-Resistance vs. Junction Temperature

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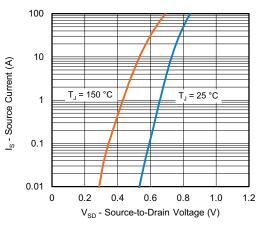
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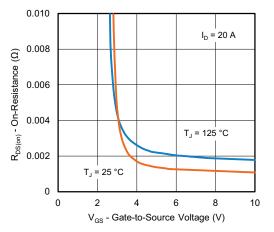


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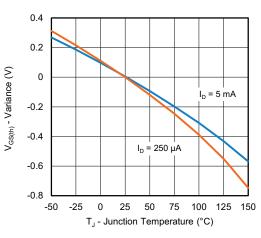
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



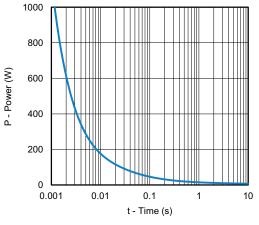
Source-Drain Diode Forward Voltage



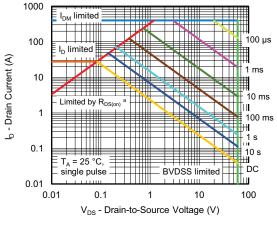
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

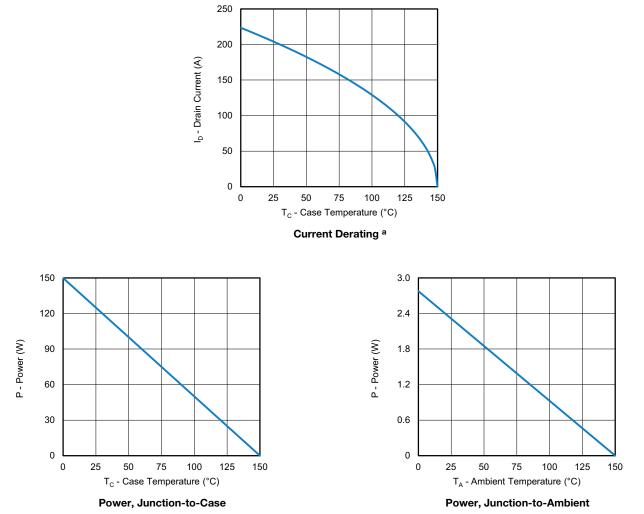
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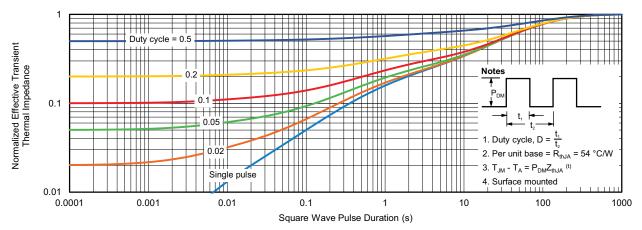
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

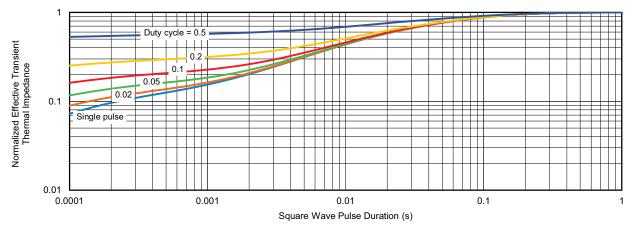


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77277.

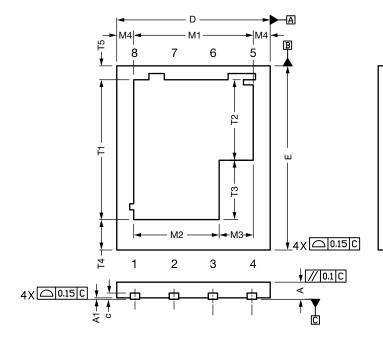
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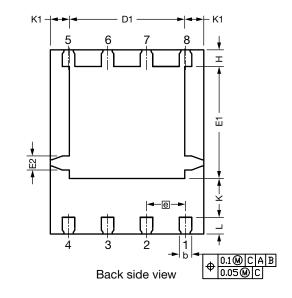


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PowerPAK[®] SO-8 Double Cooling Case Outline

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	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.51	0.56	0.61	0.020	0.022	0.024	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
b	0.36	0.41	0.46	0.014	0.016	0.018	
С	0.15	0.20	0.25	0.006	0.008	0.010	
D	4.90	5.00	5.10	0.193	0.197	0.201	
D1	3.71	3.76	3.81	0.146	0.148	0.150	
е		1.27 BSC			0.050 BSC		
E	5.90	6.00	6.10	0.232	0.236	0.240	
E1	3.60	3.65	3.70	0.142	0.144	0.146	
E2	0.46 typ.			0.018 typ.			
Н	0.49	0.54	0.59	0.019	0.021	0.023	
К	1.22	1.27	1.32	0.048	0.050	0.052	
K1		0.64 typ.		0.025 typ.			
L	0.49	0.54	0.59	0.019	0.021	0.023	
M1	3.85	3.90	3.95	0.152	0.154	0.156	
M2	2.74	2.79	2.84	0.108	0.110	0.112	
M3	1.06	1.11	1.16	0.042	0.044	0.046	
M4		0.56 typ.		0.022 typ.			
Ν		8		8			
T1	4.51	4.56	4.61	0.178	0.180	0.182	
T2	2.58	2.63	2.68	0.102	0.104	0.106	
T3	1.88	1.93	1.98	0.074	0.076	0.078	
T4	0.97 typ.			0.038 typ.			
T5	0.48 typ.			0.019 typ.			
√: T21-0014-Re	v. B, 08-Feb-2021						

Revison: 08-Feb-2021

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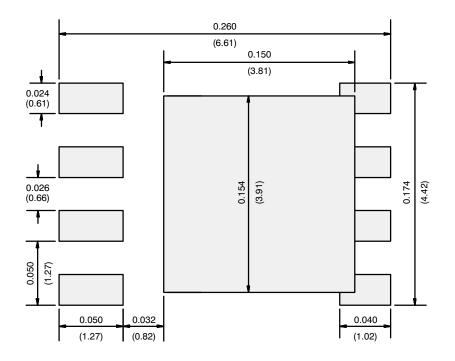
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Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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